PCN # 1917

DATE: February 21, 2019

EXPECTED PCN SHIP DATE: February 21, 2019



Quality Assurance 160 Rio Robles San Jose, CA 95134

www.maximintegrated.com

PROCESS CHANGE NOTICE	
X PRODUCT CHANGE NOTICE	1

MAXIM INTEGRATED HEREBY ISSUES NOTIFICATION OF CHANGE THAT MAY AFFECT THE FOLLOWING CATEGORIES: DESIGN X WAFER FAB ☐ ASSEMBLY **ELEC/MECH SPECS** TEST AFFECTED PRODUCT: Ordering P/N: (See PN listing XLS in PCN ZIP file) CHANGE FROM: -CHANGE TO: -MAX17260, MAX17261, MAX17262 and MAX17263: Existing source for wafer fabrication at TowerJazz/Texas (TJT), Additional source for wafer fabrication at Powerchip using S18 process technology facility/Taiwan (Fab101)using same S18 process technology JUSTIFICATION: -Due to strong demand for Maxim products we are adding Fab101 to be an additional wafer source for these devices. Adding Fab101 is required to ensure supply continuity. Upon the Expected PCN Ship Date, either fabrication facility will be used as a source of supply for these devices. Maxim has been shipping other devices in high volume from Powerchip (Fab101) fabricated in this process technology since 2010. Reliability report per AEC-Q100 with qualification results is attached (ref. FAB101_S18_FQ) There are no changes to the form, fit, function of the devices.

TRACEABILITY: Maxim Integrated maintains full traceability by device marking, packaging labels and shipment documents.

Maxim Integrated's Change Notification System is designed to keep our customer base apprised of major product, manufacturing, or facility improvements.

or

Nasser Ali Chaouche

Nasser AliChaouche / PCN Coordinator

For further information, please contact either of the people listed below.

Contact your local Maxim Integrated Company Representative

Nasser AliChaouche, PCN Coordinator 408-601-5660 / pcn.coordinator@maximintegrated.com

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